100V 1.3mΩ TOLL N-Ch Power MOSFET

Features

- Ultra-low $R_{DS(ON)}$
- Low Gate Charge
- High Current Capability
- 100% UIS Tested, 100% R_g Tested

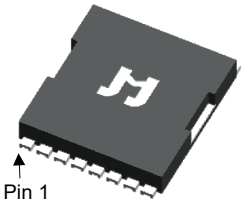
Product Summary

Parameter	Value	Unit
V_{DS}	100	V
$V_{GS(th)\_Typ}$	2.8	V
I_D (@ V_{GS} = 10V) (1)	411	A
$R_{DS(ON)\_Typ}$ (@ V_{GS} = 10V)	1.3	mΩ

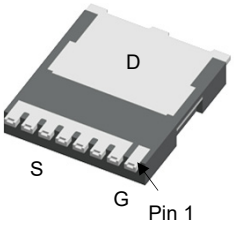
Applications

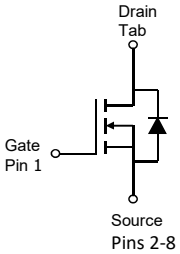
- Power Managerment in Telecom., Industrial Automation, CE
- Current/Voltage Switching in DC/DC & AC/DC Sub-systems
- Motor Driving or BMS in Power Tool, E-vehicle, Robotics

PowerJE®10x12 Top



PowerJE®10x12 Bottom





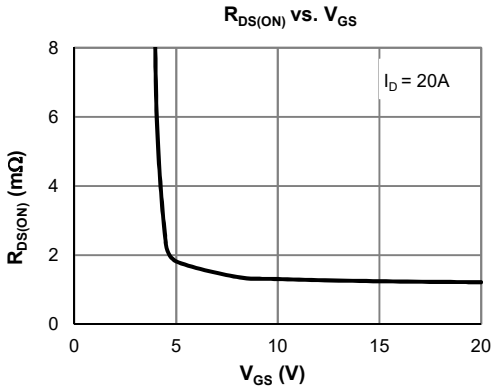
Ordering Information

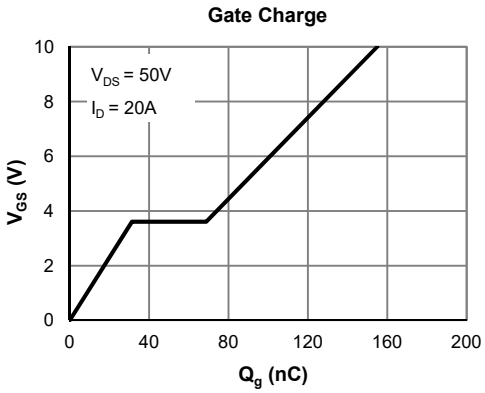
Device	Package	# of Pins	Marking	MSL	T_J (°C)	Media	Quantity (pcs)
JMSH1001ATL-13	PowerJE®10x12 (1)	8	SH1001A	1	-55 to 175	13-inch Reel	2000

Note 1: PowerJE® is a registered trademark of JieJie Micro., its package outline is compatible to that of TO-LeadLess (TOLL).

Absolute Maximum Ratings (@ T_A = 25°C unless otherwise specified)

Parameter		Symbol	Value	Unit
Drain-to-Source Voltage		V_{DS}	100	V
Gate-to-Source Voltage		V_{GS}	±20	V
Continuous Drain Current (2)	T_C = 25°C	I_D	411	A
	T_C = 100°C		290	
Continuous Drain Current (3)	T_C = 25°C	I_D	300	A
Pulsed Drain Current (4)		I_{DM}	1343	A
Avalanche Current (5)		I_{AS}	50	A
Avalanche Energy (5)		E_{AS}	1250	mJ
Power Dissipation (6)	T_C = 25°C	P_D	500	W
	T_C = 100°C		250	
Junction & Storage Temperature Range		T_J, T_{STG}	-55 to 175	°C





Electrical Characteristics (@ T_J = 25°C unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
STATIC PARAMETERS						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	I_D = 250μA, V_{GS} = 0V	100			V
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = 80V, V_{GS} = 0V			1.0	μA
		T_J = 55°C			5.0	
Gate-Body Leakage Current	I_{GSS}	V_{DS} = 0V, V_{GS} = ±20V			±100	nA
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = 250μA	2.0	2.8	4.0	V
Static Drain-Source ON-Resistance	$R_{DS(ON)}$	V_{GS} = 10V, I_D = 20A		1.3	1.6	mΩ
Forward Transconductance	g_{FS}	V_{DS} = 5V, I_D = 20A		94		S
Diode Forward Voltage	V_{SD}	I_S = 1A, V_{GS} = 0V		0.7	1.0	V
Diode Continuous Current	I_S	T_C = 25°C			500	A
DYNAMIC PARAMETERS [7]						
Input Capacitance	C_{iss}	V_{GS} = 0V, V_{DS} = 50V, f = 1MHz		9623		pF
Output Capacitance	C_{oss}			2091		pF
Reverse Transfer Capacitance	C_{rss}			1.2		pF
Gate Resistance	R_g	V_{GS} = 0V, V_{DS}= 0V, f = 1MHz		2.4		Ω
SWITCHING PARAMETERS [7]						
Total Gate Charge (@ V_{GS} = 10V)	Q_g	V_{GS} = 0 to 10V V_{DS} = 50V, I_D = 20A		155		nC
Total Gate Charge (@ V_{GS} = 6.0V)	Q_g			101		nC
Gate Source Charge	Q_{gs}			31		nC
Gate Drain Charge	Q_{gd}			37		nC
Turn-On DelayTime	$t_{D(on)}$	V_{GS} = 10V, V_{DS} = 50V R_L = 2.5Ω, R_{GEN} = 6Ω		34		ns
Turn-On Rise Time	t_r			67		ns
Turn-Off DelayTime	$t_{D(off)}$			145		ns
Turn-Off Fall Time	t_f			111		ns
Body Diode Reverse Recovery Time	t_{rr}	I_F = 15A, dI_F/dt = 100A/μs		76		ns
Body Diode Reverse Recovery Charge	Q_{rr}	I_F = 15A, dI_F/dt = 100A/μs		116		nC

Thermal Performance

Parameter	Symbol	Typ.	Max.	Unit
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	35	45	°C/W
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	0.20	0.30	°C/W

Notes:

2. Computed continuous current assumes the condition of T_{J_Max} while the actual continuous current depends on the thermal & electro-mechanical application board design.
3. Continuous current rating is limited by the package used.
4. This single-pulse measurement was taken under T_{J_Max} = 175°C.
5. This single-pulse measurement was taken under the following condition [L = 1mH, V_{GS} = 10V, V_{DS} = 50V] while its value is limited by TJ_Max = 175°C.
6. The power dissipation P_D is based on T_{J_Max} = 175°C.
7. This value is guaranteed by design hence it is not included in the production test.

Typical Electrical & Thermal Characteristics

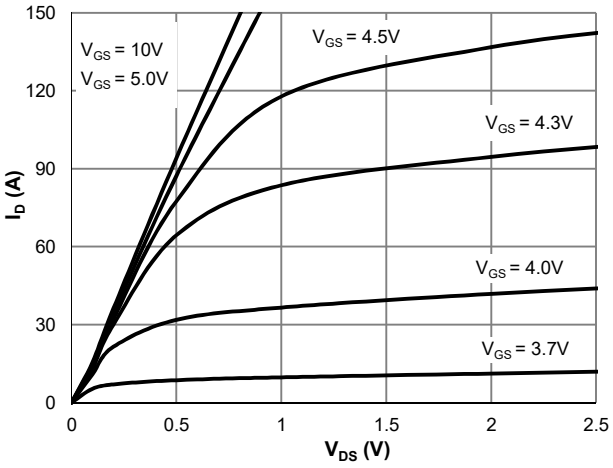


Figure 1: Saturation Characteristics

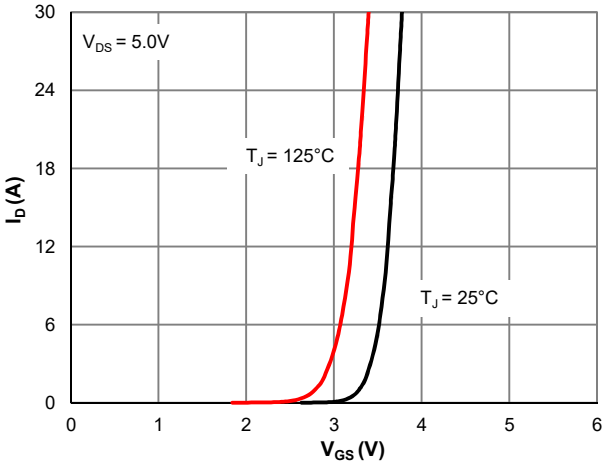


Figure 2: Transfer Characteristics

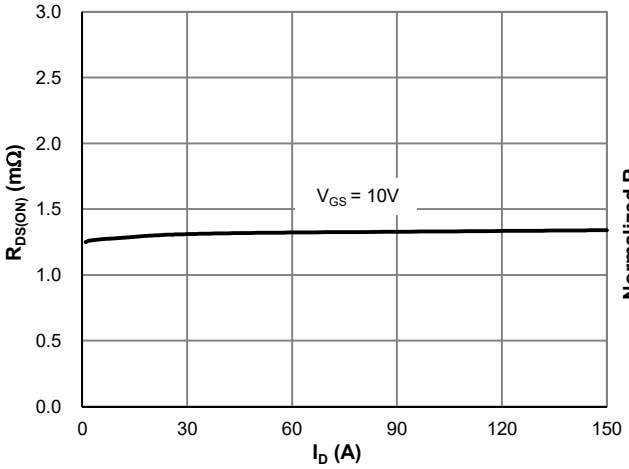


Figure 3: $R_{DS(ON)}$ vs. Drain Current

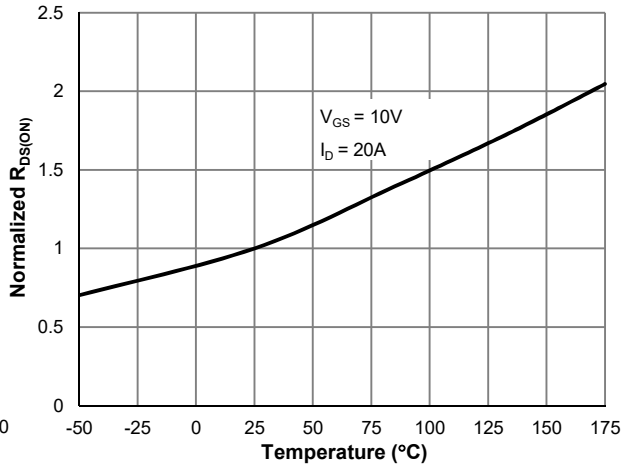


Figure 4: $R_{DS(ON)}$ vs. Junction Temperature

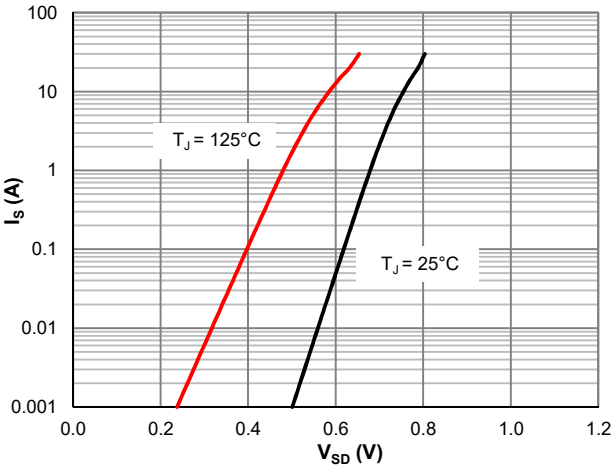


Figure 5: Body-Diode Characteristics

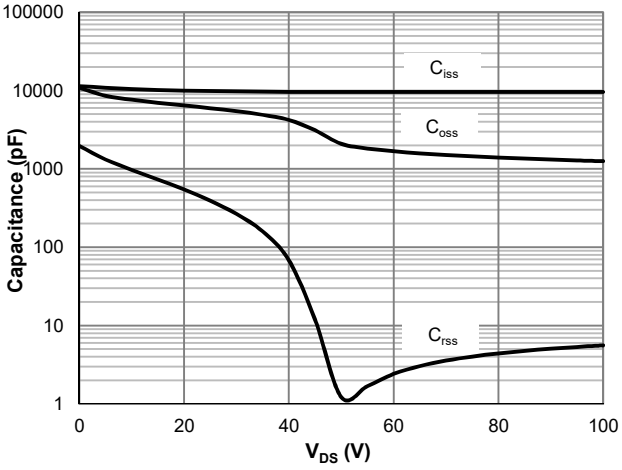


Figure 6: Capacitance Characteristics

Typical Electrical & Thermal Characteristics

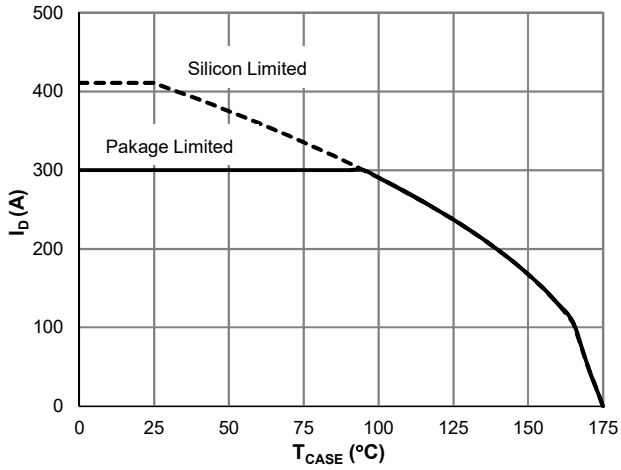


Figure 7: Current De-rating

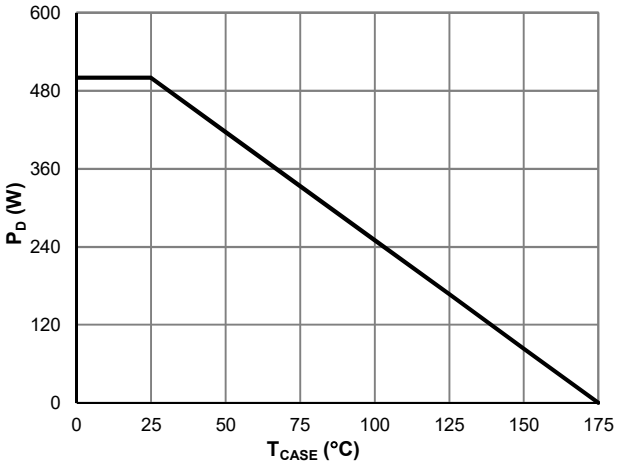


Figure 8: Power De-rating

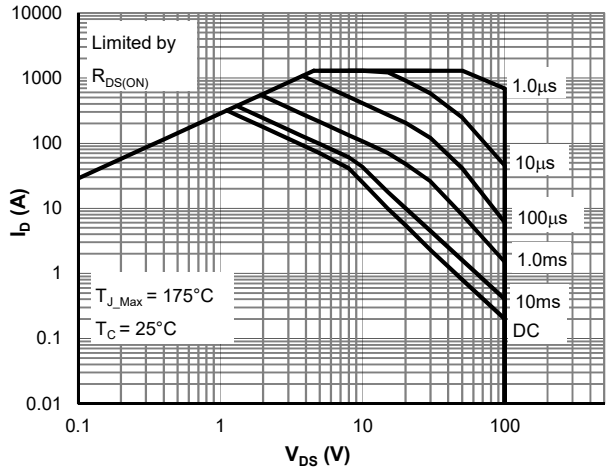


Figure 9: Maximum Safe Operating Area

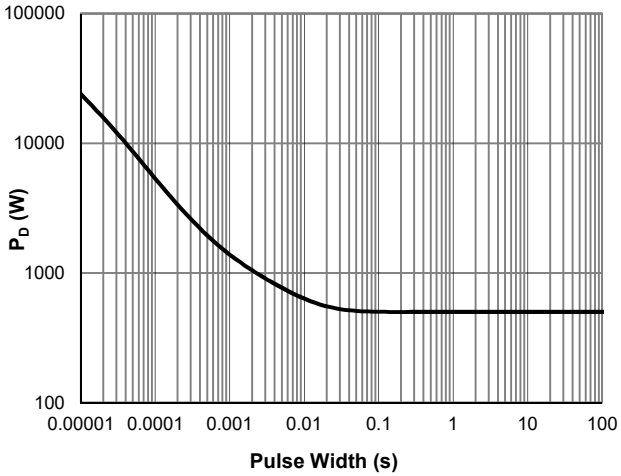


Figure 10: Single Pulse Power Rating, Junction-to-Case

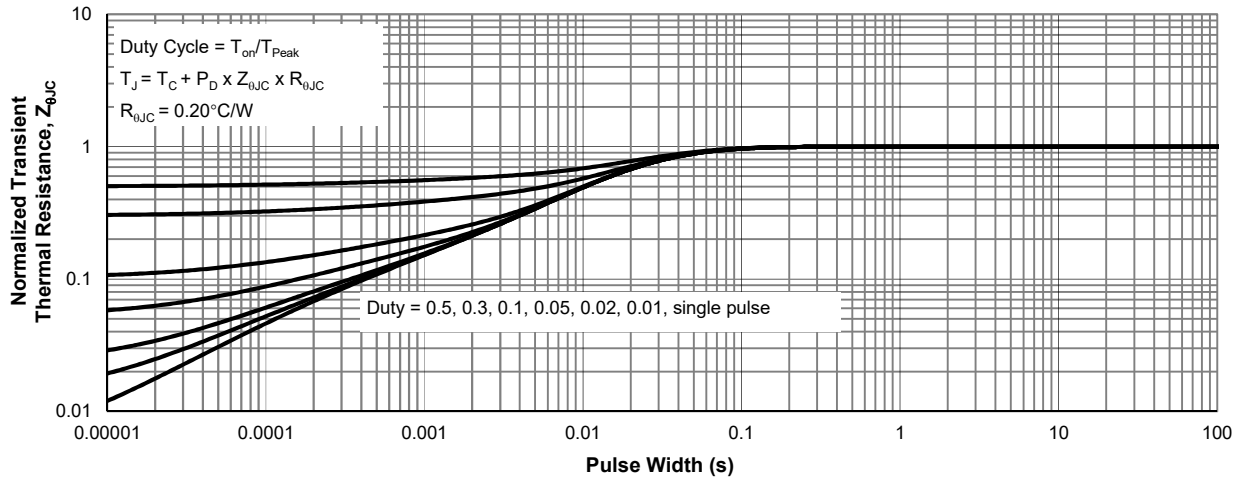
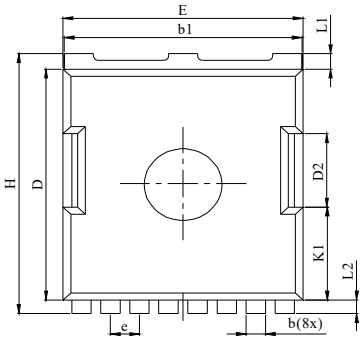


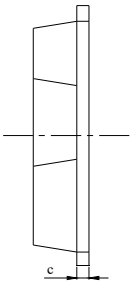
Figure 11: Normalized Maximum Transient Thermal Impedance

PowerJE®10x12 Package Information

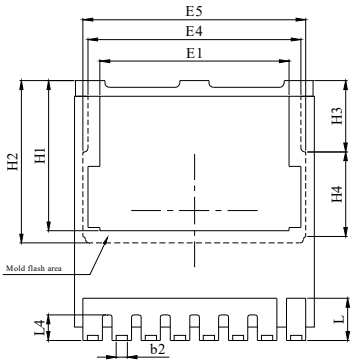
Package Outlines



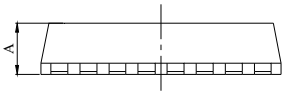
Top View



Side View



Bottom View

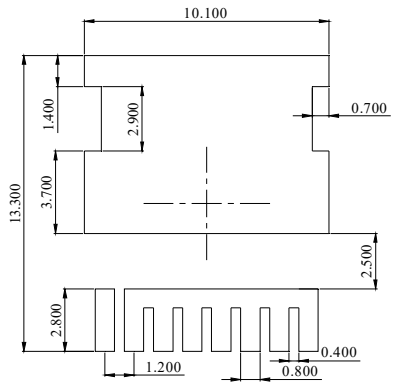


Front View

NOTES:
1. Dimension and tolerance per ASME Y14.5M, 1994.
2. All dimensions in millimeter.
3. Dimensions do not include burrs or mold flash. Mold flash or burrs does not exceed 0.150mm.

DIM.	MILLIMETER		
	MIN.	NOM.	MAX.
A	2.20	2.30	2.40
b	0.70	0.80	0.90
b1	9.70	9.80	9.90
b2	0.42	0.46	0.50
c	0.40	0.50	0.60
D	10.28	10.38	10.58
D2		3.30	
E	9.70	9.90	10.10
E1		7.80	
E4		8.80	
E5		9.20	
e		1.20 (BSC)	
H	11.48	11.68	11.88
H1	6.55	6.75	6.85
H2		7.30	
H3		3.20	
H4		3.80	
K1		4.18	
L	1.70	1.90	2.10
L1		0.70	
L2		0.60	
L4	1.00	1.15	1.30

Recommended Soldering Footprint



DIMENSIONS:MILLIMETERS